

Data sheet Product EMB 215 150 SA



Cases>Heat dissipating case

Embedded case

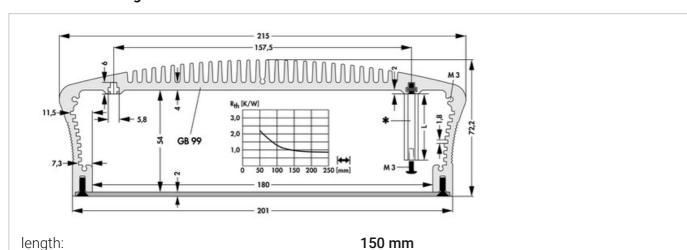
contents of delivery: $1 = 1 \times \text{case profile}$; $2 = 2 \times \text{cover panel}$; $3 = 1 \times \text{bottom panel}$; 4 = mounting material

- universal cooling fin case made of aluminium extruded profile, cover panels in 2 mm thickness and removable bottom panel
- · optimized heat dissipation by means of external cooling fins
- the integrated T-grooves in the case profile for mounting of i.e. mainboards in the Mini-ITX or NUC form factor by means of distance, bolts and mounting plate also EBX, Nano ITX, EPIC, ETX/XTX and PC/104 form factors by means
- internal guide grooves for inserting PCBs or mounting plates
- wall-, ceiling- or top-hat rail mounting by means of fixing straps or top-hat rail mounting from the bottom
- special designs, embedded cover panels, machinings, surfaces and printings upon request

Features

surface:	black anodised
way of fixation (optional):	fixing of mounting railmounting strap set

Technical Drawing



^{*} accessories mounting set BFS

Further Information



Fischer Elektronik GmbH & Co. KG
DEUTSCHLAND • GERMANY • ALLEMAGNE

Nottebohmstraße 28 58511 Lüdenscheid Telefon +49 2351 435-0 Telefax +49 2351 45754 info@fischerelektronik.de www.fischerelektronik.de